



SCCS064B - August 1994 - Revised September 2001

# 20-Bit Buffers/Line Drivers

#### **Features**

- Ioff Supports Partial-Power-Down Mode Operation
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of -40°C to +85°C
- $V_{CC} = 5V \pm 10\%$

### CY74FCT16827T Features:

- 64 mA sink current, 32 mA source current
- Typical  $V_{OLP}$  (ground bounce) <1.0V at  $V_{CC}$  = 5V,  $T_A$  = 25°C

#### CY74FCT162827T Features:

- · Balanced 24 mA output drivers
- · Reduced system switching noise
- Typical  $V_{OLP}$  (ground bounce) <0.6V at  $V_{CC}$  = 5V,  $T_A$  = 25°C

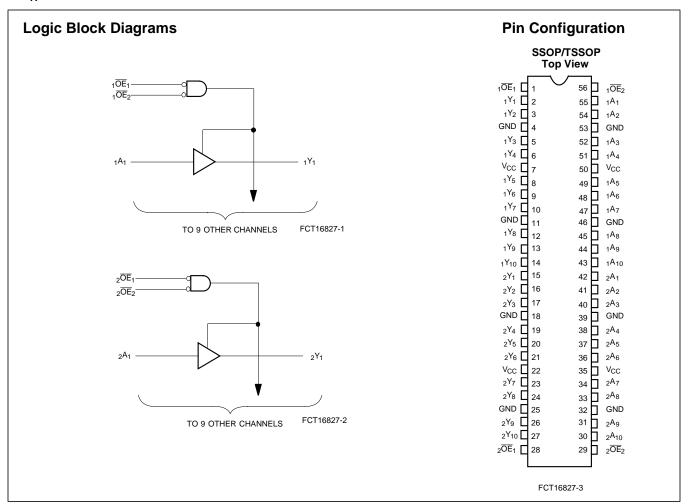
### **Functional Description**

The CY74FCT16827T 20-bit buffer/line driver and the CY74FCT162827T 20-bit buffer/line driver provide high-performance bus interface buffering for wide data/address paths or buses carrying parity. These parts can be used as a single 20-bit buffer or two 10-bit buffers. Each 10-bit buffer has a pair of NANDed  $\overline{OE}$  for increased flexibility.

This device is fully specified for partial-power-down applications using  $I_{\text{off}}$ . The  $I_{\text{off}}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The CY74FCT16827T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162827T has 24-mA balanced output drivers with current-limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162827T is ideal for driving transmission lines.





## **Pin Description**

| Name | Description                       |  |  |  |  |  |
|------|-----------------------------------|--|--|--|--|--|
| ŌĒ   | Output Enable Inputs (Active LOW) |  |  |  |  |  |
| Α    | Data Inputs                       |  |  |  |  |  |
| Υ    | Three-State Outputs               |  |  |  |  |  |

### Function Table<sup>[1]</sup>

|                 | Outputs         |   |   |
|-----------------|-----------------|---|---|
| OE <sub>1</sub> | ŌE <sub>2</sub> | Α | Y |
| L               | L               | L | L |
| L               | L               | Н | Н |
| Н               | Х               | Х | Z |
| X               | Н               | Х | Z |

# Maximum Ratings<sup>[2, 3]</sup>

| (Above which the useful life may be impaired. For use guidelines, not tested.) |
|--|
| Storage Temperature55°C to +125°C  |
| Ambient Temperature with Power Applied –55°C to +125°C                         |
| DC Input Voltage0.5V to +7.0V  |
| DC Output Voltage0.5V to +7.0V   |
| DC Output Current (Maximum Sink Current/Pin)60 to +120 mA                      |
| Power Dissipation1.0W  |
| Static Discharge Voltage>2001V (per MIL-STD-883, Method 3015)                  |

## **Operating Range**

| Range      | Ambient<br>Temperature | V <sub>CC</sub> |
|------------|------------------------|-----------------|
| Industrial | –40°C to +85°C         | 5V ± 10%        |

## **Electrical Characteristics** Over the Operating Range

| Parameter        | Description  | Test Conditions  | Min. | Typ. <sup>[4]</sup> | Max. | Unit |
|------------------|--|--|------|---------------------|------|------|
| V <sub>IH</sub>  | Input HIGH Voltage   |  | 2.0  |                     |      | V    |
| V <sub>IL</sub>  | Input LOW Voltage  |  |      |                     | 0.8  | V    |
| V <sub>H</sub>   | Input Hysteresis <sup>[5]</sup>                            |  |      | 100                 |      | mV   |
| V <sub>IK</sub>  | Input Clamp Diode Voltage                                  | V <sub>CC</sub> =Min., I <sub>IN</sub> =-18 mA             |      | -0.7                | -1.2 | V    |
| I <sub>IH</sub>  | Input HIGH Current   | V <sub>CC</sub> =Max., V <sub>I</sub> =V <sub>CC</sub>     |      |                     | ±1   | μΑ   |
| I <sub>IL</sub>  | Input LOW Current  | V <sub>CC</sub> =Max., V <sub>I</sub> =GND                 |      |                     | ±1   | μΑ   |
| l <sub>OZH</sub> | High Impedance Output<br>Current (Three-State Output pins) | V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.7V              |      |                     | ±1   | μА   |
| I <sub>OZL</sub> | High Impedance Output<br>Current (Three-State Output pins) | V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.5V              |      |                     | ±1   | μА   |
| Ios              | Short Circuit Current <sup>[6]</sup>                       | V <sub>CC</sub> =Max., V <sub>OUT</sub> =GND               | -80  | -140                | -200 | mA   |
| Io               | Output Drive Current <sup>[6]</sup>                        | V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.5V              | -50  |                     | -180 | mA   |
| I <sub>OFF</sub> | Power-Off Disable  | V <sub>CC</sub> =0V, V <sub>OUT</sub> ≤4.5V <sup>[7]</sup> |      |                     | ±1   | μΑ   |

### **Output Drive Characteristics for CY74FCT16827T**

| Parameter       | Description         | Test Conditions                                | Test Conditions Min. Typ. <sup>[4]</sup> |     | Max. | Unit |
|-----------------|---------------------|--|--|-----|------|------|
| V <sub>OH</sub> | Output HIGH Voltage | V <sub>CC</sub> =Min., I <sub>OH</sub> =-3 mA  | 2.5                                      | 3.5 |      | V    |
|                 |                     | V <sub>CC</sub> =Min., I <sub>OH</sub> =-15 mA | 2.4                                      | 3.5 |      |      |
|                 |                     | V <sub>CC</sub> =Min., I <sub>OH</sub> =-32 mA | 2.0                                      | 3.0 |      |      |
| V <sub>OL</sub> | Output LOW Voltage  | V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA  |  | 0.2 | 0.55 | V    |

- H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care.Z = HIGH Impedance.

  Operation beyond the limits set forth may impair the useful life of the device. Unless noted, these limits are over the operating free-air temperature range. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V<sub>CC</sub> or ground.

  Typical values are at V<sub>CC</sub> = 5.0V, T<sub>A</sub> = +25°C ambient.

  This parameter is specified but not tested.

- Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, Ios tests should be performed last.
- 7. Tested at +25°C.



## **Output Drive Characteristics for CY74FCT162827T**

| Parameter        | Description                        | Test Conditions   | Min. | Typ. <sup>[4]</sup> | Max. | Unit |
|------------------|------------------------------------|---|------|---------------------|------|------|
| I <sub>ODL</sub> | Output LOW Current <sup>[6]</sup>  | V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V | 60   | 115                 | 150  | mA   |
| I <sub>ODH</sub> | Output HIGH Current <sup>[6]</sup> | $V_{CC}$ =5V, $V_{IN}$ = $V_{IH}$ or $V_{IL}$ , $V_{OUT}$ =1.5V                                   | -60  | -115                | -150 | mA   |
| V <sub>OH</sub>  | Output HIGH Voltage                | V <sub>CC</sub> =Min., I <sub>OH</sub> =-24 mA  | 2.4  | 3.3                 |      | V    |
| V <sub>OL</sub>  | Output LOW Voltage                 | V <sub>CC</sub> =Min., I <sub>OL</sub> =24 mA   |      | 0.3                 | 0.55 | V    |

# **Capacitance**<sup>[5]</sup> ( $T_A = +25^{\circ}C$ , f = 1.0 MHz)

| Parameter        | Description        | Test Conditions       | Typ. <sup>[4]</sup> | Max. | Unit |
|------------------|--------------------|-----------------------|---------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance  | $V_{IN} = 0V$         | 4.5                 | 6.0  | pF   |
| C <sub>OUT</sub> | Output Capacitance | V <sub>OUT</sub> = 0V | 5.5                 | 8.0  | pF   |

## **Power Supply Characteristics**

| Parameter        | Description   | Test Condi   | tions   | Min. | Typ. <sup>[4]</sup> | Max.                 | Unit   |
|------------------|---|--|---|------|---------------------|----------------------|--------|
| I <sub>CC</sub>  |   |  | $V_{IN} \leq 0.2V$ , $V_{IN} \geq V_{CC} = 0.2V$            | _    | 5                   | 500                  | μΑ     |
| Δl <sub>CC</sub> | Quiescent Power Supply<br>Current (TTL inputs HIGH) | V <sub>CC</sub> =Max.  | V <sub>IN</sub> =3.4V <sup>[8]</sup>                        | _    | 0.5                 | 1.5                  | mA     |
| I <sub>CCD</sub> | Dynamic Power Supply<br>Current <sup>[9]</sup>      | V <sub>CC</sub> =Max.,<br>One Input Toggling,<br>50% Duty Cycle,<br>Outputs Open,<br>OE <sub>1</sub> =OE <sub>2</sub> =GND,            | V <sub>IN</sub> =V <sub>CC</sub> or<br>V <sub>IN</sub> =GND | _    | 60                  | 100                  | μA/MHz |
| I <sub>C</sub>   | Total Power Supply Current <sup>[10]</sup>          | V <sub>CC</sub> =Max.,<br>f <sub>1</sub> =10 MHz,  | V <sub>IN</sub> =V <sub>CC</sub> or<br>V <sub>IN</sub> =GND | _    | 0.6                 | 1.5                  | mA     |
|                  |   | 50% Duty Cycle,<br>Outputs Open,<br>One Bit Toggling,<br>OE <sub>1</sub> =OE <sub>2</sub> =GND   | V <sub>IN</sub> =3.4V or<br>V <sub>IN</sub> =GND            | _    | 0.9                 | 2.3                  |        |
|                  |   | V <sub>CC</sub> =Max.,<br>f <sub>1</sub> =2.5 MHz,   | V <sub>IN</sub> =V <sub>CC</sub> or<br>V <sub>IN</sub> =GND | _    | 3.0                 | 5.5 <sup>[11]</sup>  |        |
|                  | (<br> -   | 50% Duty Cycle,<br>Outputs Open,<br>Twenty Bits Toggling,<br>$\overline{\text{OE}}_1 = \overline{\text{OE}}_2 = \overline{\text{GND}}$ | V <sub>IN</sub> =3.4V or<br>V <sub>IN</sub> =GND            | _    | 8.0                 | 20.5 <sup>[11]</sup> |        |

#### Notes:

8. Per TTL driven input ( $V_{IN}$ =3.4V); all other inputs at  $V_{CC}$  or GND.

This parameter is not directly testable, but is derived for use in Total Power Supply calculations.  $\begin{array}{ll}
l_{C} &= l_{QUIESCENT} + l_{INPUTS} + l_{DYNAMIC} \\
l_{C} &= l_{CC} + \Delta l_{CC} D_{H} N_{T} + l_{CCD} (f_{0}/2 + f_{1}N_{1}) \\
l_{CC} &= Quiescent Current with CMOS input levels
\end{array}$ 

 $\begin{array}{lll} \Delta I_{CC} &=& \text{Power Supply Current for a TTL HIGH input } (V_{IN} = 3.4V) \\ D_H &=& \text{Duty Cycle for TTL inputs HIGH} \\ N_T &=& \text{Number of TTL inputs at D}_H \end{array}$ 

I<sub>CCD</sub> = Dynamic Current caused by an input transition pair (HLH or LHL)

= Clock frequency for registered devices, otherwise zero

= Input signal frequency

= Number of inputs changing at f<sub>1</sub>

All currents are in milliamps and all frequencies are in megahertz.

11. Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are specified but not tested.



# Switching Characteristics Over the Operating $\mathsf{Range}^{[12]}$

|                                   |                               |                                     | CY74FCT |      | CY74FCT | 162827BT |      |                          |
|-----------------------------------|-------------------------------|-------------------------------------|---------|------|---------|----------|------|--------------------------|
| Parameter                         | Description                   | Condition <sup>[13]</sup>           | Min.    | Max. | Min.    | Max.     | Unit | Fig. No. <sup>[13]</sup> |
| t <sub>PLH</sub> t <sub>PHL</sub> | Propagation Delay<br>A to Y   | $C_L$ =50 pF $R_L$ =500 $\Omega$    | 1.5     | 8.0  | 1.5     | 5.0      | ns   | 1, 3                     |
|                                   |                               | $C_L$ =300 pF $R_L$ =500 $\Omega$   | 1.5     | 15.0 | 1.5     | 13.0     |      |                          |
| t <sub>PZH</sub>                  | Output Enable Time<br>OE to Y | $C_L$ =50 pF $R_L$ =500 $\Omega$    | 1.5     | 12.0 | 1.5     | 8.0      | ns   | 1, 7, 8                  |
|                                   |                               | $C_L$ =300 pF $R_L$ =500 $\Omega$   | 1.5     | 23.0 | 1.5     | 15.0     |      |                          |
| t <sub>PHZ</sub> t <sub>PLZ</sub> | Output Disable Time OE to Y   | $C_L=5 pF$ $R_L=500\Omega$          | 1.5     | 9.0  | 1.5     | 6.0      | ns   | 1, 7, 8                  |
|                                   |                               | $C_L$ =50 pF<br>$R_L$ =500 $\Omega$ | 1.5     | 10.0 | 1.5     | 7.0      |      |                          |
| t <sub>SK(O)</sub>                | Output Skew <sup>[14]</sup>   |                                     | _       | 0.5  | _       | 0.5      | ns   | _                        |

|                                      |                             |                                     | CY74FCT16827CT<br>CY74FCT162827CT |      |      |                          |
|--------------------------------------|-----------------------------|-------------------------------------|-----------------------------------|------|------|--------------------------|
| Parameter                            | Description                 | Condition <sup>[12]</sup>           | Min.                              | Max. | Unit | Fig. No. <sup>[13]</sup> |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>A to Y | $C_L$ =50 pF<br>$R_L$ =500 $\Omega$ | 1.5                               | 4.2  | ns   | 1, 3                     |
|                                      |                             | $C_L$ =300 pF $R_L$ =500 $\Omega$   | 1.5                               | 10.0 |      |                          |
| t <sub>PZH</sub> t <sub>PZL</sub>    | Output Enable Time OE to Y  | $C_L$ =50 pF<br>$R_L$ =500 $\Omega$ | 1.5                               | 5.6  | ns   | 1, 7, 8                  |
|                                      |                             | $C_L$ =300 pF $R_L$ =500 $\Omega$   | 1.5                               | 14.0 |      |                          |
| t <sub>PHZ</sub>                     | Output Disable Time OE to Y | $C_L=5 pF$ $R_L=500\Omega$          | 1.5                               | 5.7  | ns   | 1, 7, 8                  |
|                                      |                             | $C_L$ =50 pF<br>$R_L$ =500 $\Omega$ | 1.5                               | 6.0  |      |                          |
| t <sub>SK(O)</sub>                   | Output Skew <sup>[14]</sup> |                                     | _                                 | 0.5  | ns   | _                        |

### Notes:

Minimum limits are specified but not tested on Propagation Delays.
 See "Parameter Measurement Information" in the General Information section.
 Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.



# Ordering Information CY74FCT16827

| Speed<br>(ns) | Ordering Code          | Package<br>Name | Package Type            | Operating<br>Range |
|---------------|------------------------|-----------------|-------------------------|--------------------|
| 4.2           | CY74FCT16827CTPACT     | Z56             | 56-Lead (240-Mil) TSSOP | Industrial         |
|               | CY74FCT16827CTPVC/PVCT | O56             | 56-Lead (300-Mil) SSOP  |                    |
| 8.0           | CY74FCT16827ATPVC/PVCT | Z56             | 56-Lead (240-Mil) SSOP  | Industrial         |

Document #: 38-00393-C

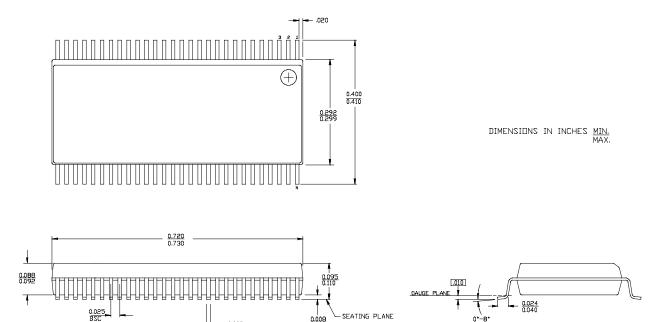
# Ordering Information CY74FCT162827

| Speed<br>(ns) | Ordering Code      | Package<br>Name | Package Type            | Operating<br>Range |
|---------------|--------------------|-----------------|-------------------------|--------------------|
| 4.2           | 74FCT162827CTPACT  | Z56             | 56-Lead (240-Mil) TSSOP | Industrial         |
|               | CY74FCT162827CTPVC | Z56             | 56-Lead (240-Mil) SSOP  |                    |
|               | 74FCT162827CTPVCT  | Z56             | 56-Lead (240-Mil) SSOP  |                    |
| 5.0           | CY74FCT162827BTPVC | O56             | 56-Lead (300-Mil) SSOP  | Industrial         |
|               | 74FCT162827BTPVCT  | O56             | 56-Lead (300-Mil) SSOP  |                    |
| 8.0           | CY74FCT162827ATPVC | O56             | 56-Lead (300-Mil) SSOP  | Industrial         |
|               | 74FCT162827ATPVCT  | O56             | 56-Lead (300-Mil) SSOP  |                    |

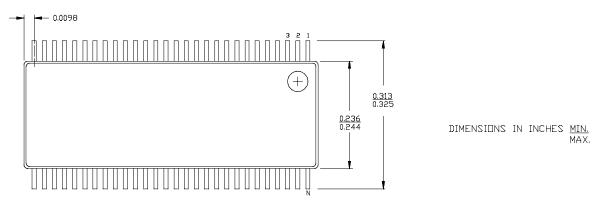


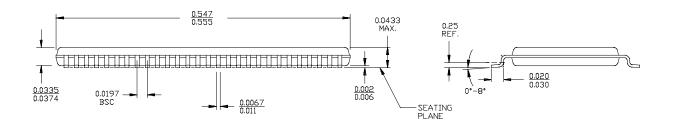
# **Package Diagrams**

## 56-Lead Shrunk Small Outline Package O56



### 56-Lead Thin Shrunk Small Outline Package Z56







## **PACKAGING INFORMATION**

| Orderable Device   | Status (1) | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| 74FCT162827ATPACT  | ACTIVE     | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162827ATPVCG4 | ACTIVE     | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162827ATPVCT  | ACTIVE     | SSOP            | DL                 | 56   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162827BTPVCG4 | ACTIVE     | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162827BTPVCT  | ACTIVE     | SSOP            | DL                 | 56   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162827CTPACT  | ACTIVE     | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT162827ETPACT  | OBSOLETE   | TSSOP           | DGG                | 56   |                | TBD                       | Call TI          | Call TI                      |
| 74FCT162827ETPVCT  | OBSOLETE   | SSOP            | DL                 | 56   |                | TBD                       | Call TI          | Call TI                      |
| 74FCT16827ATPACTE4 | ACTIVE     | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16827ATPACTG4 | ACTIVE     | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16827ATPVCG4  | ACTIVE     | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16827ATPVCTG4 | ACTIVE     | SSOP            | DL                 | 56   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16827CTPACTE4 | ACTIVE     | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16827CTPACTG4 | ACTIVE     | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16827CTPVCG4  | ACTIVE     | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74FCT16827CTPVCTG4 | ACTIVE     | SSOP            | DL                 | 56   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT162827ATPVC | ACTIVE     | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT162827BTPVC | ACTIVE     | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT162827ETPAC | OBSOLETE   | TSSOP           | DGG                | 56   |                | TBD                       | Call TI          | Call TI                      |
| CY74FCT162827ETPVC | OBSOLETE   | SSOP            | DL                 | 56   |                | TBD                       | Call TI          | Call TI                      |
| CY74FCT16827ATPACT | ACTIVE     | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16827ATPVC  | ACTIVE     | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16827ATPVCT | ACTIVE     | SSOP            | DL                 | 56   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16827CTPACT | ACTIVE     | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16827CTPVC  | ACTIVE     | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16827CTPVCT | ACTIVE     | SSOP            | DL                 | 56   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| CY74FCT16827ETPAC  | OBSOLETE   | TSSOP           | DGG                | 56   |                | TBD                       | Call TI          | Call TI                      |





.com 27-Sep-2007

| Orderable Device   | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup>    | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| CY74FCT16827ETPACT | OBSOLETE              | TSSOP           | DGG                | 56   |                | TBD                        | Call TI          | Call TI                      |
| CY74FCT16827ETPVC  | OBSOLETE              | SSOP            | DL                 | 56   |                | TBD                        | Call TI          | Call TI                      |
| CY74FCT16827ETPVCT | OBSOLETE              | SSOP            | DL                 | 56   |                | TBD                        | Call TI          | Call TI                      |
| FCT162827ATPACTE4  | ACTIVE                | TSSOP           | DGG                | 56   | 2000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| FCT162827ATPACTG4  | ACTIVE                | TSSOP           | DGG                | 56   | 2000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| FCT162827ATPVCTG4  | ACTIVE                | SSOP            | DL                 | 56   | 1000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| FCT162827BTPVCTG4  | ACTIVE                | SSOP            | DL                 | 56   | 1000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| FCT162827CTPACTE4  | ACTIVE                | TSSOP           | DGG                | 56   | 2000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| FCT162827CTPACTG4  | ACTIVE                | TSSOP           | DGG                | 56   | 2000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

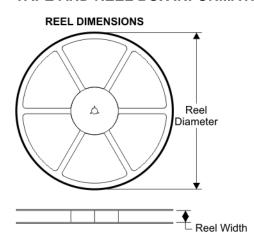
Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

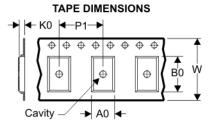
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



v.ti.com 4-Oct-2007

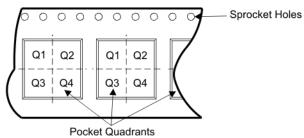
### TAPE AND REEL BOX INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device             | Package | Pins | Site    | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------------|---------|------|---------|--------------------------|-----------------------|---------|---------|---------|------------|-----------|------------------|
| 74FCT162827ATPACT  | DGG     | 56   | SITE 41 | 330                      | 24                    | 8.6     | 15.6    | 1.8     | 12         | 24        | Q1               |
| 74FCT162827ATPVCT  | DL      | 56   | SITE 41 | 330                      | 32                    | 11.35   | 18.67   | 3.1     | 16         | 32        | Q1               |
| 74FCT162827BTPVCT  | DL      | 56   | SITE 41 | 330                      | 32                    | 11.35   | 18.67   | 3.1     | 16         | 32        | Q1               |
| 74FCT162827CTPACT  | DGG     | 56   | SITE 41 | 330                      | 24                    | 8.6     | 15.6    | 1.8     | 12         | 24        | Q1               |
| CY74FCT16827ATPACT | DGG     | 56   | SITE 41 | 330                      | 24                    | 8.6     | 15.6    | 1.8     | 12         | 24        | Q1               |
| CY74FCT16827ATPVCT | DL      | 56   | SITE 41 | 330                      | 32                    | 11.35   | 18.67   | 3.1     | 16         | 32        | Q1               |
| CY74FCT16827CTPACT | DGG     | 56   | SITE 41 | 330                      | 24                    | 8.6     | 15.6    | 1.8     | 12         | 24        | Q1               |
| CY74FCT16827CTPVCT | DL      | 56   | SITE 41 | 330                      | 32                    | 11.35   | 18.67   | 3.1     | 16         | 32        | Q1               |





| Device             | Package | Pins | Site    | Length (mm) | Width (mm) | Height (mm) |
|--------------------|---------|------|---------|-------------|------------|-------------|
| 74FCT162827ATPACT  | DGG     | 56   | SITE 41 | 346.0       | 346.0      | 41.0        |
| 74FCT162827ATPVCT  | DL      | 56   | SITE 41 | 346.0       | 346.0      | 49.0        |
| 74FCT162827BTPVCT  | DL      | 56   | SITE 41 | 346.0       | 346.0      | 49.0        |
| 74FCT162827CTPACT  | DGG     | 56   | SITE 41 | 346.0       | 346.0      | 41.0        |
| CY74FCT16827ATPACT | DGG     | 56   | SITE 41 | 346.0       | 346.0      | 41.0        |
| CY74FCT16827ATPVCT | DL      | 56   | SITE 41 | 346.0       | 346.0      | 49.0        |
| CY74FCT16827CTPACT | DGG     | 56   | SITE 41 | 346.0       | 346.0      | 41.0        |
| CY74FCT16827CTPVCT | DL      | 56   | SITE 41 | 346.0       | 346.0      | 49.0        |

### DL (R-PDSO-G\*\*)

### **48 PINS SHOWN**

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| Products              |                        | Applications       |                           |
|-----------------------|------------------------|--------------------|---------------------------|
| Amplifiers            | amplifier.ti.com       | Audio              | www.ti.com/audio          |
| Data Converters       | dataconverter.ti.com   | Automotive         | www.ti.com/automotive     |
| DSP                   | dsp.ti.com             | Broadband          | www.ti.com/broadband      |
| Interface             | interface.ti.com       | Digital Control    | www.ti.com/digitalcontrol |
| Logic                 | logic.ti.com           | Military           | www.ti.com/military       |
| Power Mgmt            | power.ti.com           | Optical Networking | www.ti.com/opticalnetwork |
| Microcontrollers      | microcontroller.ti.com | Security           | www.ti.com/security       |
| RFID                  | www.ti-rfid.com        | Telephony          | www.ti.com/telephony      |
| Low Power<br>Wireless | www.ti.com/lpw         | Video & Imaging    | www.ti.com/video          |
|                       |                        | Wireless           | www.ti.com/wireless       |

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated